

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
Stylesheet Version v1.2

EPAS ID: PAT6457375

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
DZAFIR BIN MOHD SHARIFF	12/15/2020
ENRIQUE JR SARILE	12/15/2020
SEUNG GEUN PARK	12/17/2020
RECEIVING PARTY DATA	
Name:	UTAC HEADQUARTERS PTE. LTD.
Street Address:	22 ANG MO KIO INDUSTRIAL PARK 2
City:	SINGAPORE
State/Country:	SINGAPORE
Postal Code:	569506
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	17125917
CORRESPONDENCE DATA	
Fax Number:	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	+65 9836 9908
Email:	info@horizonip.com.sg
Correspondent Name:	HORIZON IP PTE LTD
Address Line 1:	7500A BEACH ROAD
Address Line 2:	#04-306/308 THE PLAZA
Address Line 4:	SINGAPORE, SINGAPORE 199591
ATTORNEY DOCKET NUMBER:	UTACP2019NAT100US0
NAME OF SUBMITTER:	DEXTER KAM CHIN
SIGNATURE:	/dexter chin/
DATE SIGNED:	12/17/2020
This document serves as an Oath/Declaration (37 CFR 1.63).	
Total Attachments: 3	
source=SG1905DeclAssign_Dzafir#page1.tif	
source=SG1905DeclAssign_Enrique#page1.tif	

COMBINED DECLARATION and ASSIGNMENT (37 CFR 1.63) FOR UTILITY OR DESIGN APPLICATION USING AN APPLICATION DATA SHEET (37 CFR 1.76)

Title of Invention	SEMICONDUCTOR PACKAGES WITHOUT DEBRIS
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DECLARATION

As the below named inventor, I hereby declare that:

This declaration is directed to: The attached application, or
 United States application or PCT international application number _____ filed on _____

The above-identified application was made or authorized to be made by me.

I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

I have reviewed and understand the contents of the application and am aware of the duty to disclose to the US Patent and Trademark Office all information known to me to be material to patentability as defined in 37 CFR § 1.56.

ASSIGNMENT

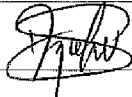
For good and valuable consideration, the receipt, sufficiency and adequacy of which are hereby acknowledged, I hereby sell, assign, transfer, to **UTAC Headquarters Pte. Ltd.** having a business address of **22 Ang Mo Kio Industrial Park 2, Singapore 569506** its successors and assigns, absolutely and forever, my entire right, title and interest in and to the invention listed above, together with the Application, any and all Patents that may issue in the United States and/or any foreign countries, and any reissues, re-examinations, renewals, continuations, continuation-in-parts, divisionals or extensions thereof that may be issued or granted, and all right, title and interest to the inventions contained in said Patents and Applications, for the United States and all foreign countries, and all the rights and privileges relating thereto including but not limited to the priority rights arising from said Applications, the right to recover and take all such proceedings as may be necessary for the recovery of damages or otherwise in respect of past, present and future infringement, and the right to apply for, take and maintain patents on said inventions.

If any portion of this Combined Declaration or Assignment is held unenforceable, then remaining portions hereof shall nevertheless remain in full force and effect.

LEGAL NAME OF INVENTOR

Inventor: Dzafir Bin Mohd SHARIFF

Date: 15/12/2020

Signature: 

Note: An application data sheet (PTO/SB/14 or equivalent), including naming the entire inventive entity, must accompany this form. Use an additional form for each additional inventor.

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ASSIGNMENT

For good and valuable consideration, the receipt, sufficiency and adequacy of which are hereby acknowledged, I hereby sell, assign, transfer, to **UTAC Headquarters Pte. Ltd.** having a business address of **22 Ang Mo Kio Industrial Park 2, Singapore 569506** its successors and assigns, absolutely and forever, my entire right, title and interest in and to the invention listed above, together with the Application, any and all Patents that may issue in the United States and/or any foreign countries, and any reissues, re-examinations, renewals, continuations, continuation-in-parts, divisionals or extensions thereof that may be issued or granted, and all right, title and interest to the inventions contained in said Patents and Applications, for the United States and all foreign countries, and all the rights and privileges relating thereto including but not limited to the priority rights arising from said Applications, the right to recover and take all such proceedings as may be necessary for the recovery of damages or otherwise in respect of past, present and future infringement, and the right to apply for, take and maintain patents on said inventions.

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LEGAL NAME OF INVENTOR

Inventor: Enrique Jr SARILE _____

Date : 15-DEC-2020 _____

Signature:  _____

Note: An application data sheet (PFO/SB/14 or equivalent), including naming the entire inventive entity, must accompany this form. Use an additional form for each additional inventor.

COMBINED DECLARATION and ASSIGNMENT (37 CFR 1.63) FOR UTILITY OR DESIGN APPLICATION USING AN APPLICATION DATA SHEET (37 CFR 1.76)

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LEGAL NAME OF INVENTOR

Inventor: Seung Geun PARK Date : 17 Dec 2020

Signature: 

Note: An application data sheet (PTO/SB/14 or equivalent), including naming the entire inventive entity, must accompany this form. Use an additional form for each additional inventor.